

1-22-99

Docket No. JCLA339

02-02-1999

Form 595
1-31-92

RECORDED



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U.S. Department of Commerce
Patent and Trademark Office

10549 U.S. PTO
09/235262
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To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.

- | | |
|--|--|
| 1. Name of conveying party(ies):

Chih-Hsun Chu,
Hong-Tsz Pan
Ming-Tzong Yang | 2. Name/address of receiving Party(ies):

United Silicon Incorporated

No. 3, Li-Hsin II Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. |
| 3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment
<input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Other
<input type="checkbox"/> Change of Name <input type="checkbox"/> Reassignment | |
| 4. Date(s) of execution: December 18, 1998. <small>Add names of receiving parties</small>
<small>Attached?</small> <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | |
| 5. Application number(s) or patent number(s):

If this documents is being filed together with a new application, the execution date of the application is December 18, 1998 | |
| A. Patent Application No. (s) B. Patent No. (s) | |
| Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | |
| 6. Name and address of party to whom correspondence concerning document should be mailed:

J.C. Patents, Inc
1540 Reynolds Ave., Suite 114
Irvine, CA 92614
(949) 660-0761 | 7. Total No. of applications and patents involved:

ONE(1)

8. Total fee (37 CFR §3.41): \$40.00

<input checked="" type="checkbox"/> Enclosed
<input type="checkbox"/> Charge to Acct. No. |
| 9. Total number of pages, including cover sheet, attachments and document 3. | |

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10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Liawei Huang
Name of Person Signing

Liawei Huang
Signature

1/22/99
Date

Registration No. 43,330

02/01/1999 SDURMS 00000132 09235262

01 FC:581

40.00 DP

PATENT
REEL: 9726 FRAME: 0950

ASSIGNMENT

WHEREAS:

1. Chih-Hsun Chu
2. Hong-Tsz Pan
3. Ming-Tzong Yang

hereinafter referred to as ASSIGNOR has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title **METHOD OF FORMING SHALLOW TRENCH ISOLATION**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS: United Silicon Incorporated

of No. 3, Li-Hsin II Rd. Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

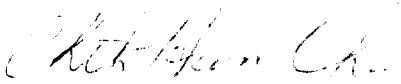
Hereinafter referred to as ASSIGNEE is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

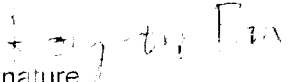
IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated



December 18, 1998

Signature

Sole or First Joint Inventor: Chih-Hsun Chu



December 18, 1998

Signature

Second Joint Inventor (if any): Hong-Tsz Pan



December 18, 1998

Signature

Third Joint Inventor (if any): Ming-Tzong Yang